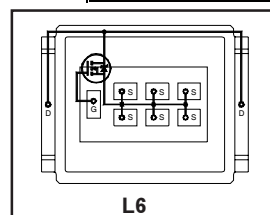


- Advanced Process Technology
- Optimized for Automotive Motor Drive, DC-DC and other Heavy Load Applications
- Exceptionally Small Footprint and Low Profile
- High Power Density
- Low Parasitic Parameters
- Dual Sided Cooling
- 175°C Operating Temperature
- Repetitive Avalanche Capability for Robustness and Reliability
- Lead Free, RoHS Compliant and Halogen Free
- Automotive Qualified \*

|                          |                   |
|--------------------------|-------------------|
| $V_{(BR)DSS}$            | 40V               |
| $R_{DS(on)}$ <b>typ.</b> | 1.5mΩ             |
|                          | <b>max.</b> 1.9mΩ |
| $I_D$ (Silicon Limited)  | 156A              |
| $Q_g$                    | 89nC              |



Applicable DirectFET® Outline and Substrate Outline ①

|    |    |  |  |    |    |  |    |    |    |  |
|----|----|--|--|----|----|--|----|----|----|--|
| SB | SC |  |  | M2 | M4 |  | L4 | L6 | L8 |  |
|----|----|--|--|----|----|--|----|----|----|--|

## Description

The AUIRF7737L2 combines the latest Automotive HEXFET® Power MOSFET Silicon technology with the advanced DirectFET® packaging technology to achieve exceptional performance in a package that has the footprint of a DPak (TO-252AA) and only 0.7 mm profile. The DirectFET® package is compatible with existing layout geometries used in power applications, PCB assembly equipment and vapor phase, infrared or convection soldering techniques, when application note AN-1035 is followed regarding the manufacturing methods and processes. The DirectFET® package allows dual sided cooling to maximize thermal transfer in automotive power systems.

This HEXFET® Power MOSFET is designed for applications where efficiency and power density are of value. The advanced DirectFET® packaging platform coupled with the latest silicon technology allows the AUIRF7737L2 to offer substantial system level savings and performance improvement specifically in motor drive, high frequency DC-DC and other heavy load applications on ICE, HEV and EV platforms. This MOSFET utilizes the latest processing techniques to achieve low on-resistance and low  $Q_g$  per silicon area. Additional features of this MOSFET are 175°C operating junction temperature and high repetitive peak current capability. These features combine to make this MOSFET a highly efficient, robust and reliable device for high current automotive applications.

## Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature ( $T_A$ ) is 25°C, unless otherwise specified.

|                                         | Parameter                                                          | Max.                     | Units |
|-----------------------------------------|--------------------------------------------------------------------|--------------------------|-------|
| V <sub>DS</sub>                         | Drain-to-Source Voltage                                            | 40                       | V     |
| V <sub>GS</sub>                         | Gate-to-Source Voltage                                             | ± 20                     |       |
| I <sub>D</sub> @ T <sub>C</sub> = 25°C  | Continuous Drain Current, V <sub>GS</sub> @ 10V (Silicon Limited)④ | 156                      | A     |
| I <sub>D</sub> @ T <sub>C</sub> = 100°C | Continuous Drain Current, V <sub>GS</sub> @ 10V (Silicon Limited)④ | 110                      |       |
| I <sub>D</sub> @ T <sub>A</sub> = 25°C  | Continuous Drain Current, V <sub>GS</sub> @ 10V (Silicon Limited)③ | 31                       |       |
| I <sub>D</sub> @ T <sub>C</sub> = 25°C  | Continuous Drain Current, V <sub>GS</sub> @ 10V (Package Limited)  | 315                      |       |
| I <sub>DM</sub>                         | Pulsed Drain Current ⑤                                             | 624                      |       |
| P <sub>D</sub> @T <sub>C</sub> = 25°C   | Power Dissipation ④                                                | 83                       | W     |
| P <sub>D</sub> @T <sub>A</sub> = 25°C   | Power Dissipation ③                                                | 3.3                      |       |
| E <sub>AS</sub>                         | Single Pulse Avalanche Energy (Thermally Limited) ⑥                | 104                      | mJ    |
| E <sub>AS</sub> (tested)                | Single Pulse Avalanche Energy Tested Value ⑥                       | 386                      |       |
| I <sub>AR</sub>                         | Avalanche Current ⑦                                                | See Fig.18a, 18b, 16, 17 | A     |
| E <sub>AR</sub>                         | Repetitive Avalanche Energy ⑦                                      |                          | mJ    |
| T <sub>P</sub>                          | Peak Soldering Temperature                                         | 270                      | °C    |
| T <sub>J</sub>                          | Operating Junction and                                             | -55 to + 175             |       |
| T <sub>STG</sub>                        | Storage Temperature Range                                          |                          |       |

## Thermal Resistance

|                    | Parameter                | Typ. | Max. | Units |
|--------------------|--------------------------|------|------|-------|
| $R_{\theta JA}$    | Junction-to-Ambient ③    | —    | 45   | °C/W  |
| $R_{\theta JA}$    | Junction-to-Ambient ⑧    | 12.5 | —    |       |
| $R_{\theta JA}$    | Junction-to-Ambient ⑨    | 20   | —    |       |
| $R_{\theta JCan}$  | Junction-to-Can ④⑩       | —    | 1.8  |       |
| $R_{\theta J-PCB}$ | Junction-to-PCB Mounted  | —    | 0.5  |       |
|                    | Linear Derating Factor ④ | 0.56 |      | W/°C  |

HEXFET® is a registered trademark of International Rectifier.

## Static Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)

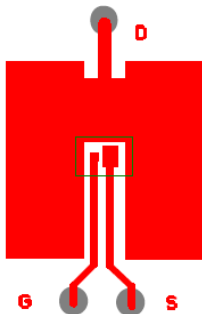
|                                 | Parameter                            | Min. | Typ. | Max. | Units                | Conditions                                           |
|---------------------------------|--------------------------------------|------|------|------|----------------------|------------------------------------------------------|
| $V_{(BR)DSS}$                   | Drain-to-Source Breakdown Voltage    | 40   | —    | —    | V                    | $V_{GS} = 0V, I_D = 250\mu A$                        |
| $\Delta V_{(BR)DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient  | —    | 0.03 | —    | V/ $^\circ\text{C}$  | Reference to $25^\circ\text{C}$ , $I_D = 1\text{mA}$ |
| $R_{DS(on)}$                    | Static Drain-to-Source On-Resistance | —    | 1.5  | 1.9  | m $\Omega$           | $V_{GS} = 10V, I_D = 94A$ ⑦                          |
| $V_{GS(th)}$                    | Gate Threshold Voltage               | 2.0  | 3.0  | 4.0  | V                    | $V_{DS} = V_{GS}, I_D = 150\mu A$                    |
| $\Delta V_{GS(th)}/\Delta T_J$  | Gate Threshold Voltage Coefficient   | —    | -10  | —    | mV/ $^\circ\text{C}$ |                                                      |
| $g_{fs}$                        | Forward Transconductance             | 100  | —    | —    | S                    | $V_{DS} = 10V, I_D = 94A$                            |
| $R_G$                           | Gate Resistance                      | —    | 0.6  | —    | $\Omega$             |                                                      |
| $I_{DSS}$                       | Drain-to-Source Leakage Current      | —    | —    | 5    | $\mu A$              | $V_{DS} = 40V, V_{GS} = 0V$                          |
|                                 |                                      | —    | —    | 250  |                      | $V_{DS} = 40V, V_{GS} = 0V, T_J = 125^\circ\text{C}$ |
| $I_{GSS}$                       | Gate-to-Source Forward Leakage       | —    | —    | 100  | nA                   | $V_{GS} = 20V$                                       |
|                                 | Gate-to-Source Reverse Leakage       | —    | —    | -100 |                      | $V_{GS} = -20V$                                      |

## Dynamic Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)

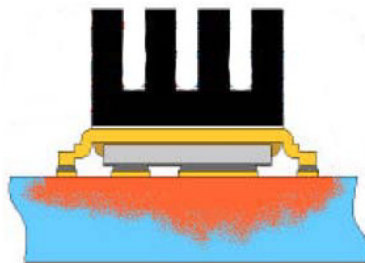
|                        | Parameter                                  | Min. | Typ. | Max. | Units | Conditions                                                 |
|------------------------|--------------------------------------------|------|------|------|-------|------------------------------------------------------------|
| $Q_g$                  | Total Gate Charge                          | —    | 89   | 134  | nC    | $V_{DS} = 20V, V_{GS} = 10V$<br>$I_D = 94A$<br>See Fig. 11 |
| $Q_{gs1}$              | Pre-V <sub>th</sub> Gate-to-Source Charge  | —    | 18   | —    |       |                                                            |
| $Q_{gs2}$              | Post-V <sub>th</sub> Gate-to-Source Charge | —    | 8    | —    |       |                                                            |
| $Q_{gd}$               | Gate-to-Drain ("Miller") Charge            | —    | 34   | —    |       |                                                            |
| $Q_{godr}$             | Gate Charge Overdrive                      | —    | 29   | —    |       |                                                            |
| $Q_{sw}$               | Switch Charge ( $Q_{gs2} + Q_{gd}$ )       | —    | 42   | —    | nC    | $V_{DS} = 16V, V_{GS} = 0V$                                |
| $Q_{oss}$              | Output Charge                              | —    | 39   | —    | nC    | $V_{DD} = 20V, V_{GS} = 10V$ ⑧                             |
| $t_{d(on)}$            | Turn-On Delay Time                         | —    | 12   | —    | ns    | $I_D = 94A$<br>$R_G = 1.8\Omega$                           |
| $t_r$                  | Rise Time                                  | —    | 19   | —    |       |                                                            |
| $t_{d(off)}$           | Turn-Off Delay Time                        | —    | 22   | —    |       |                                                            |
| $t_f$                  | Fall Time                                  | —    | 14   | —    |       |                                                            |
| $C_{iss}$              | Input Capacitance                          | —    | 5469 | —    | pF    | $V_{GS} = 0V$                                              |
| $C_{oss}$              | Output Capacitance                         | —    | 1193 | —    |       | $V_{DS} = 25V$                                             |
| $C_{rss}$              | Reverse Transfer Capacitance               | —    | 534  | —    |       | $f = 1.0\text{MHz}$                                        |
| $C_{oss}$              | Output Capacitance                         | —    | 4296 | —    |       | $V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0\text{MHz}$            |
| $C_{oss}$              | Output Capacitance                         | —    | 1066 | —    |       | $V_{GS} = 0V, V_{DS} = 32V, f = 1.0\text{MHz}$             |
| $C_{oss \text{ eff.}}$ | Effective Output Capacitance               | —    | 1615 | —    |       | $V_{GS} = 0V, V_{DS} = 0V \text{ to } 32V$                 |

## Diode Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)

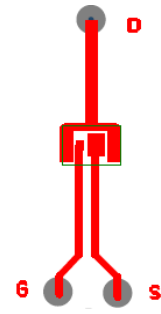
|          | Parameter                                 | Min. | Typ. | Max. | Units | Conditions                                                              |
|----------|-------------------------------------------|------|------|------|-------|-------------------------------------------------------------------------|
| $I_S$    | Continuous Source Current<br>(Body Diode) | —    | —    | 156  | A     | MOSFET symbol<br>showing the<br>integral reverse<br>p-n junction diode. |
| $I_{SM}$ | Pulsed Source Current<br>(Body Diode) ⑤   | —    | —    | 624  |       |                                                                         |
| $V_{SD}$ | Diode Forward Voltage                     | —    | —    | 1.3  | V     | $I_S = 94A, V_{GS} = 0V$ ⑦                                              |
| $t_{rr}$ | Reverse Recovery Time                     | —    | 35   | 53   | ns    | $I_F = 94A, V_{DD} = 20V$                                               |
| $Q_{rr}$ | Reverse Recovery Charge                   | —    | 32   | 48   | nC    | $di/dt = 100A/\mu s$ ⑦                                                  |



③ Surface mounted on 1 in. square Cu (still air).



⑨ Mounted to a PCB with small clip heatsink (still air)



⑩ Mounted on minimum footprint full size board with metalized back and with small clip heatsink (still air)

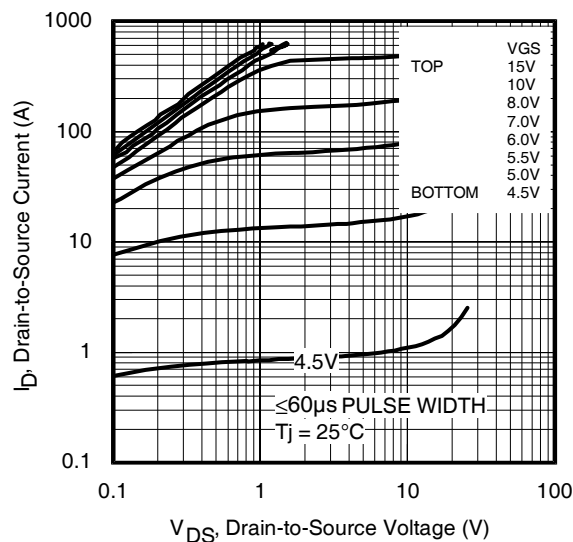
Notes ① through ⑩ are on page 10

## Qualification Information<sup>†</sup>

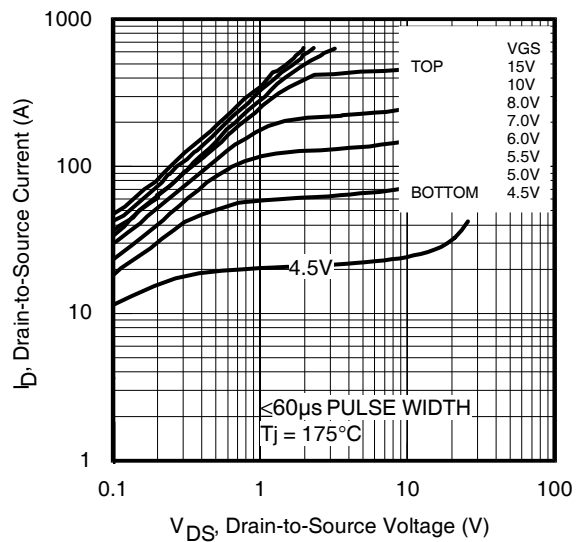
|                                   |                      |                                                                                                                                                                         |      |
|-----------------------------------|----------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| <b>Qualification Level</b>        |                      | Automotive<br>(per AEC-Q101) <sup>††</sup>                                                                                                                              |      |
|                                   |                      | Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level. |      |
| <b>Moisture Sensitivity Level</b> |                      | LARGE-CAN                                                                                                                                                               | MSL1 |
| <b>ESD</b>                        | Machine Model        | Class M4(+/-425V)<br>(per AEC-Q101-002)                                                                                                                                 |      |
|                                   | Human Body Model     | Class H1C(+/-2000V)<br>(per AEC-Q101-001)                                                                                                                               |      |
|                                   | Charged Device Model | N/A<br>(per AEC-Q101-005)                                                                                                                                               |      |
| <b>RoHS Compliant</b>             |                      | Yes                                                                                                                                                                     |      |

† Qualification standards can be found at International Rectifier's web site: <http://www.irf.com>

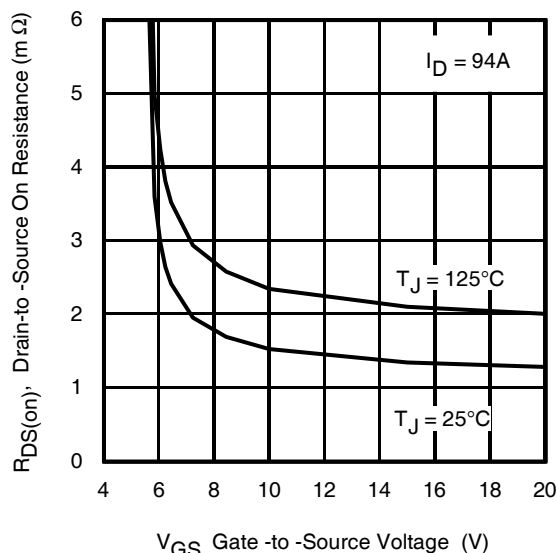
†† Exceptions to AEC-Q101 requirements are noted in the qualification report.



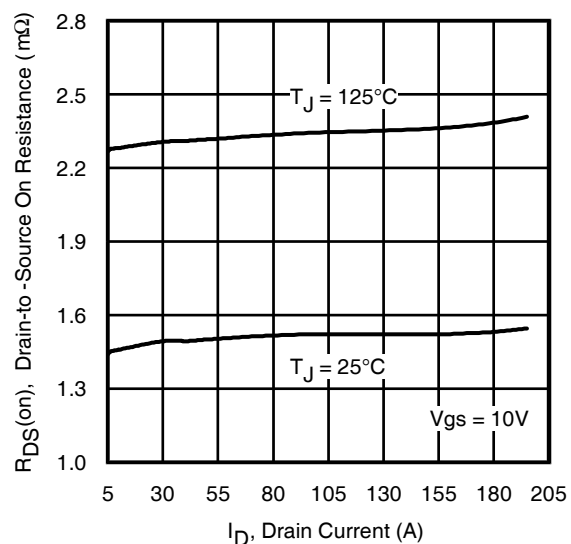
**Fig 1.** Typical Output Characteristics



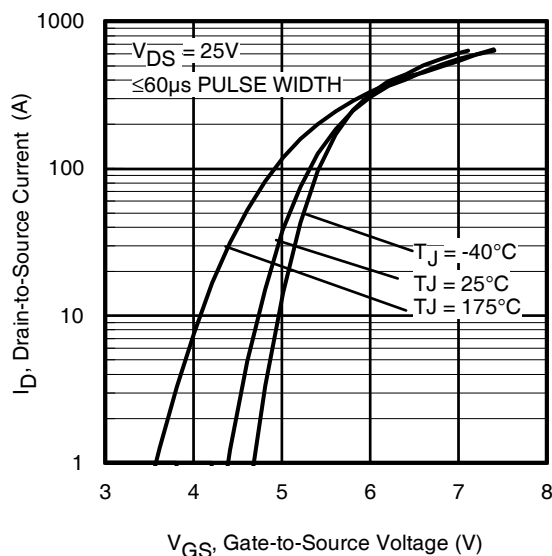
**Fig 2.** Typical Output Characteristics



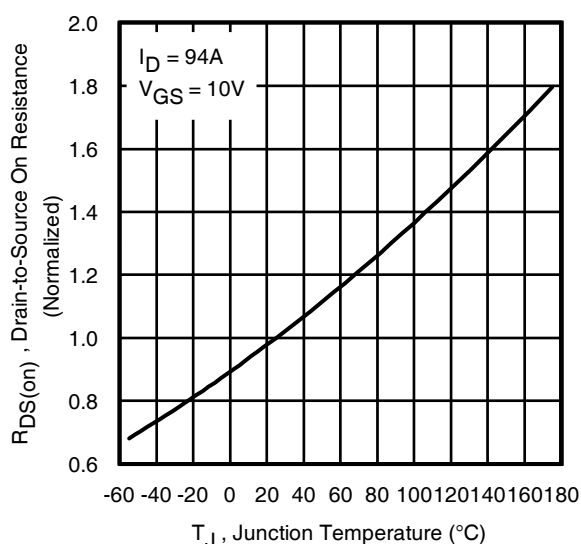
**Fig 3.** Typical On-Resistance vs. Gate Voltage



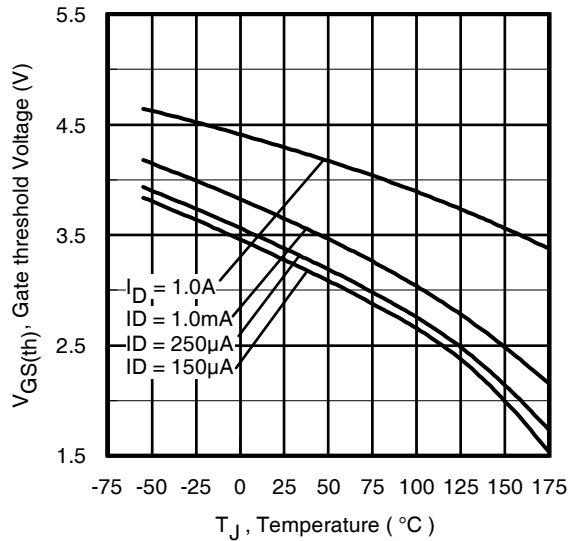
**Fig 4.** Typical On-Resistance vs. Drain Current



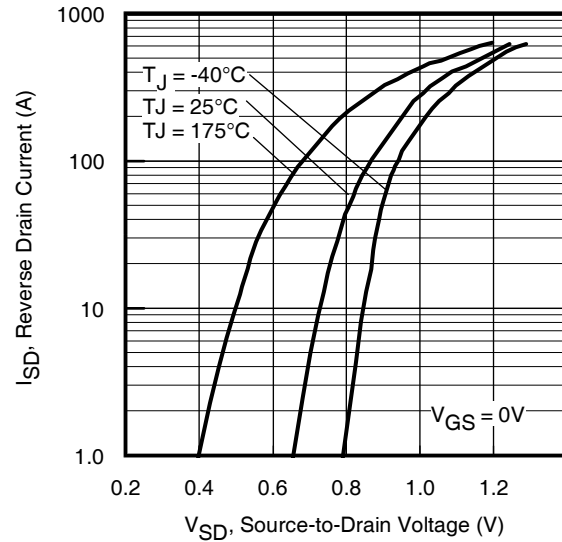
**Fig 5.** Typical Transfer Characteristics



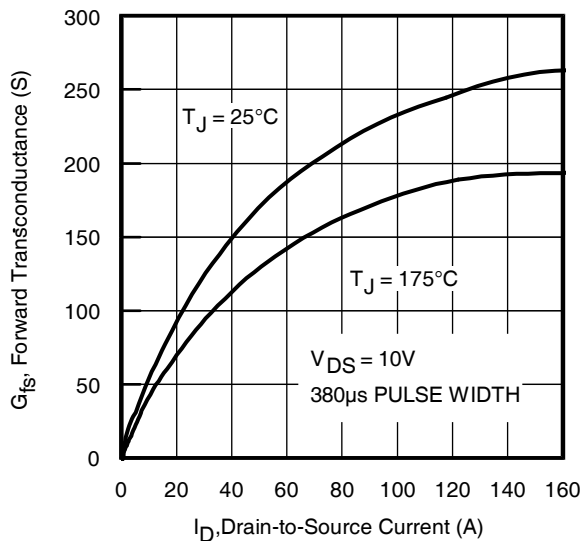
**Fig 6.** Normalized On-Resistance vs. Temperature



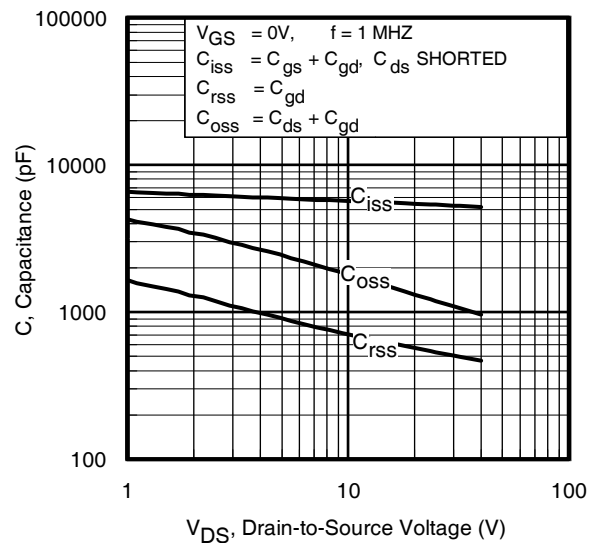
**Fig 7.** Typical Threshold Voltage vs. Junction Temperature



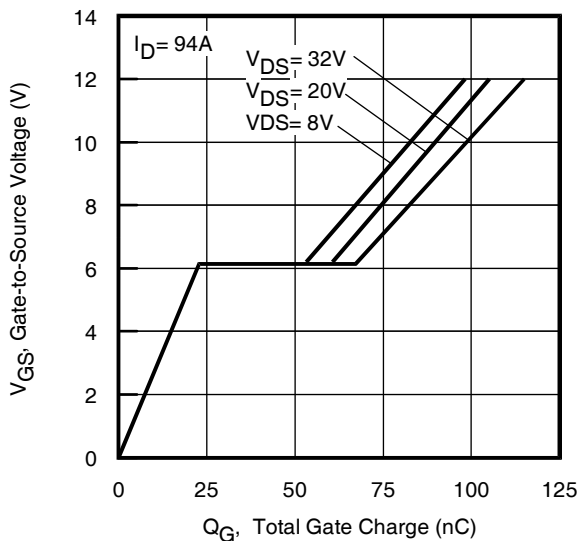
**Fig 8.** Typical Source-Drain Diode Forward Voltage



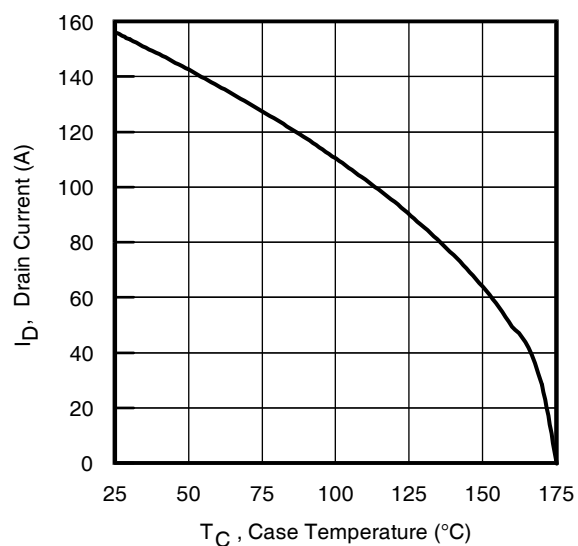
**Fig 9.** Typical Forward Transconductance Vs. Drain Current



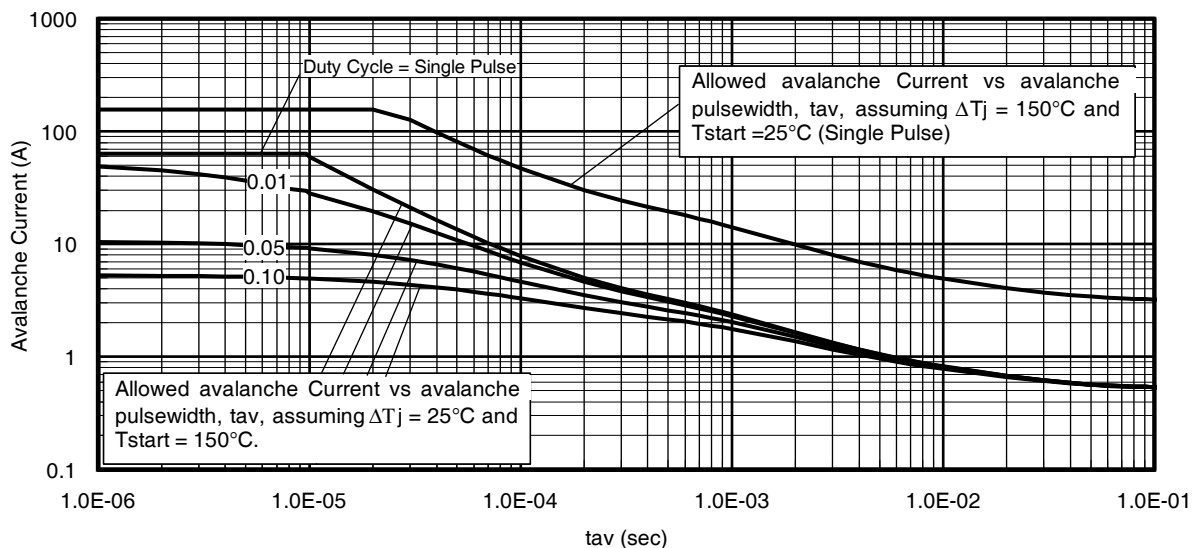
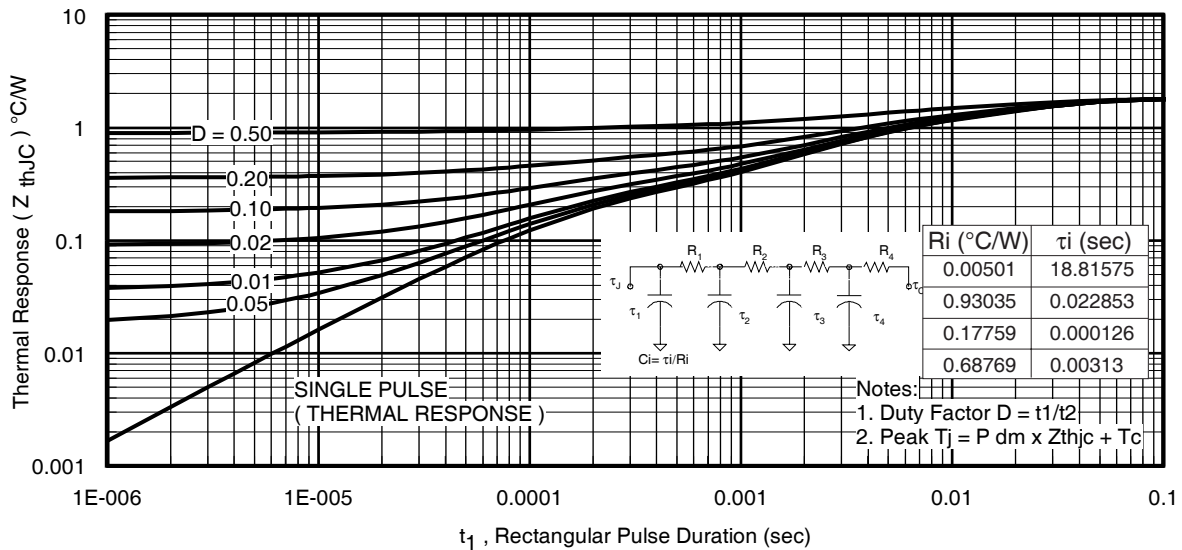
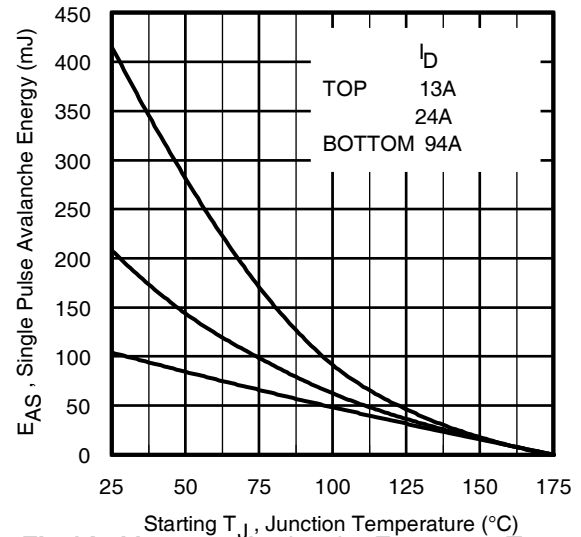
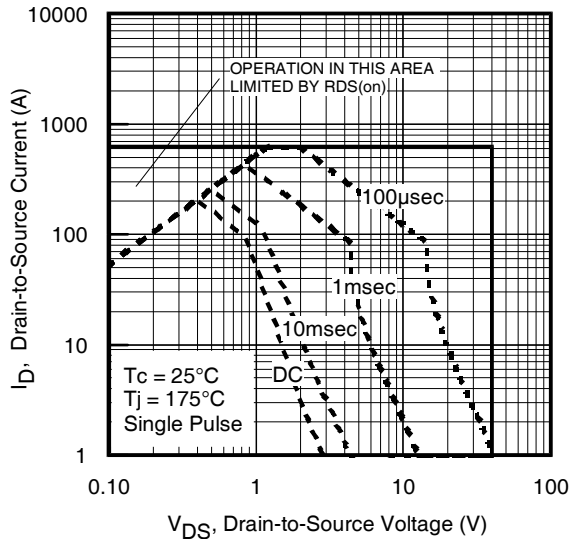
**Fig 10.** Typical Capacitance vs. Drain-to-Source Voltage

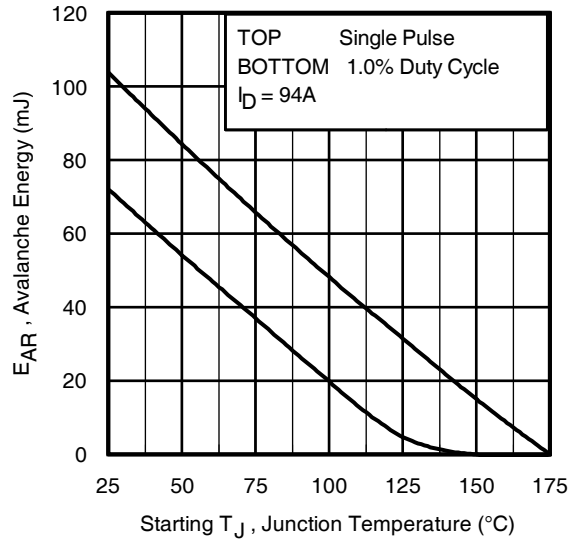


**Fig.11** Typical Gate Charge vs. Gate-to-Source Voltage  
[www.irf.com](http://www.irf.com)

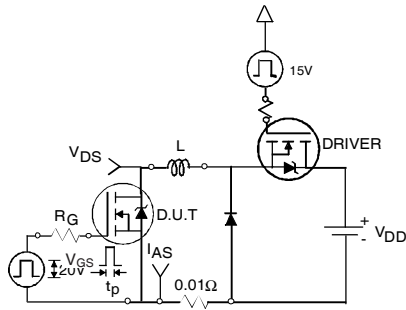


**Fig 12.** Maximum Drain Current vs. Case Temperature





**Fig 17.** Maximum Avalanche Energy Vs. Temperature

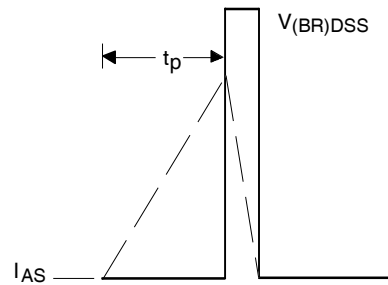


**Fig 18a.** Unclamped Inductive Test Circuit

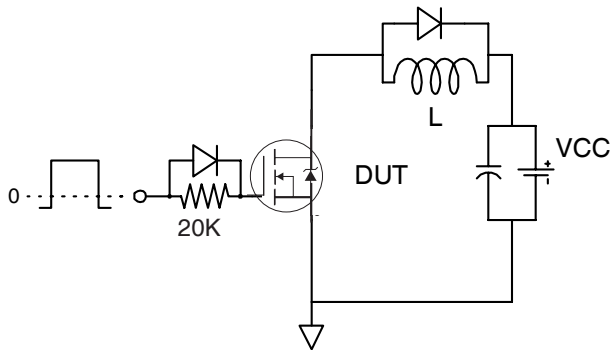
$$P_{D(ave)} = 1/2 (1.3 \cdot BV \cdot I_{av}) = \Delta T / Z_{thJC}$$

$$I_{av} = 2 \Delta T / [1.3 \cdot BV \cdot Z_{th}]$$

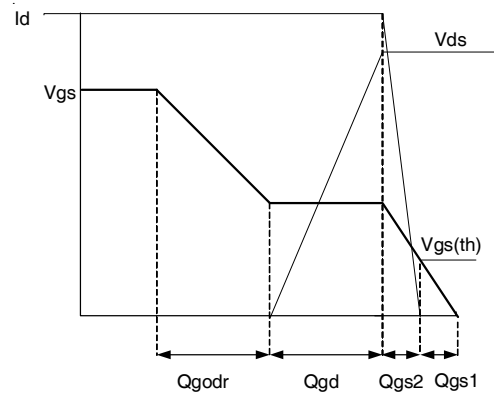
$$E_{AS(AR)} = P_{D(ave)} \cdot t_{av}$$



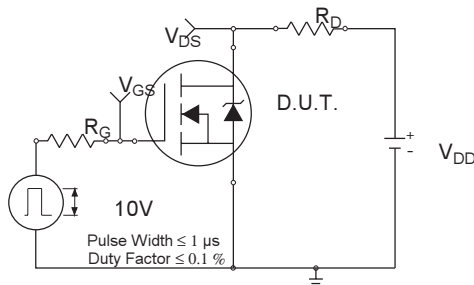
**Fig 18b.** Unclamped Inductive Waveforms



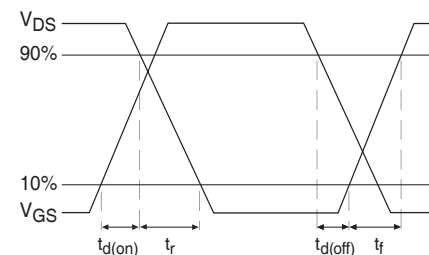
**Fig 19a.** Gate Charge Test Circuit



**Fig 19b.** Gate Charge Waveform



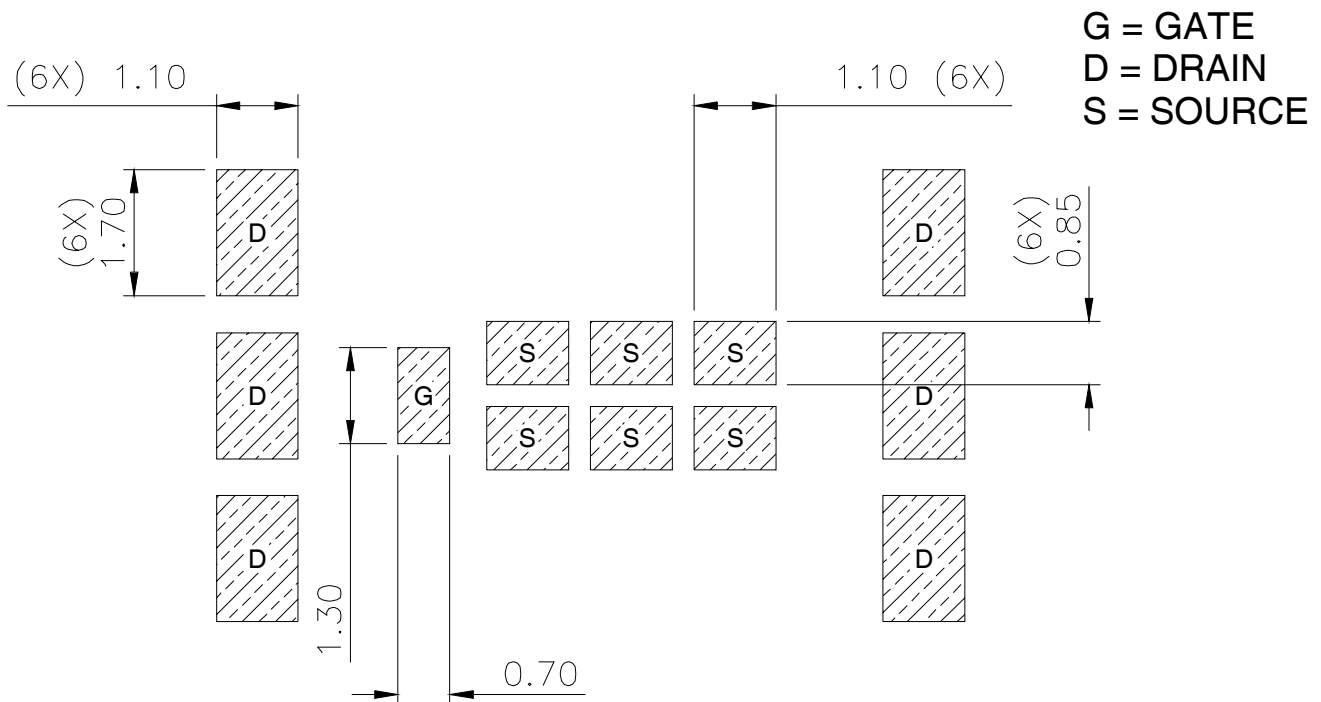
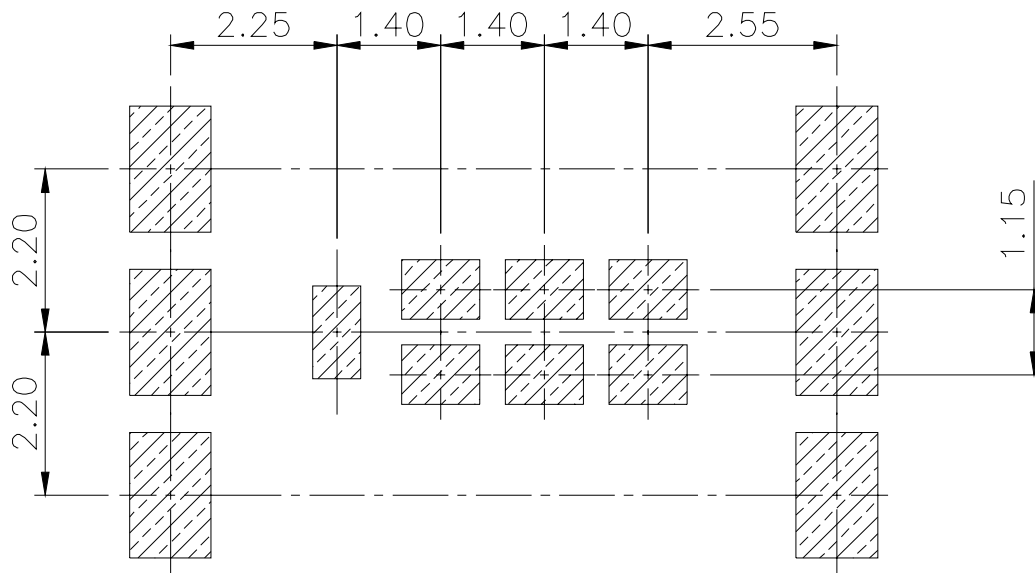
**Fig 20a.** Switching Time Test Circuit



**Fig 20b.** Switching Time Waveforms

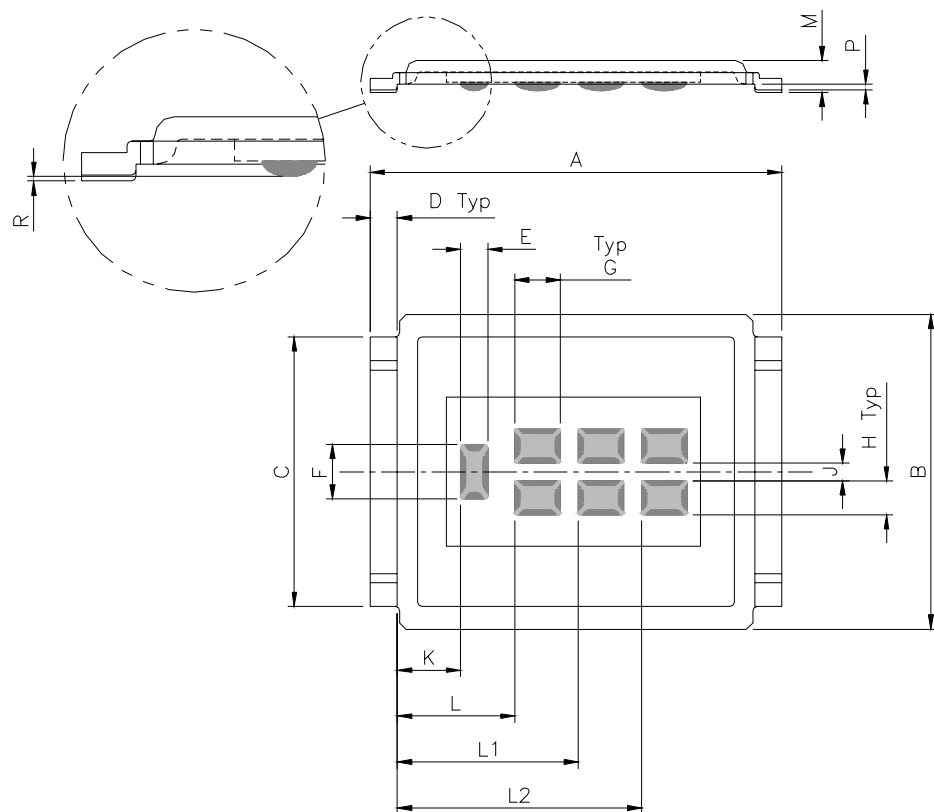
## Automotive DirectFET® Board Footprint, L6 (Large Size Can).

Please see AN-1035 for DirectFET® assembly details and stencil and substrate design recommendations



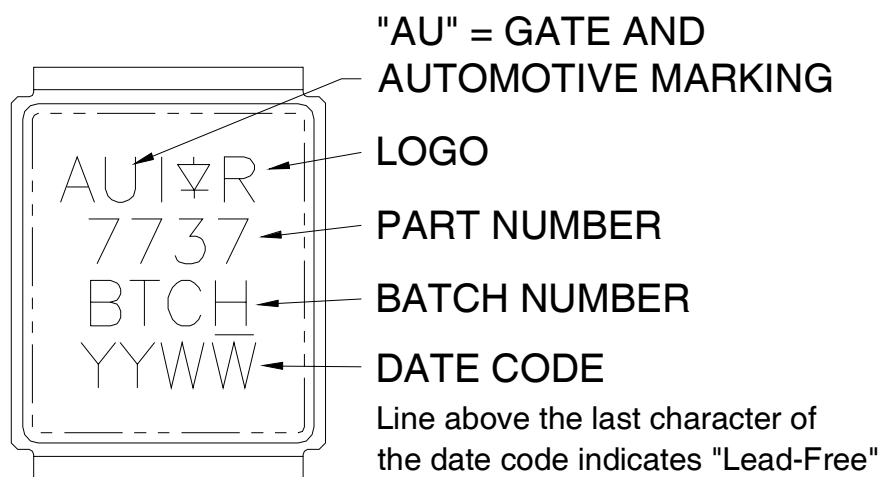
## Automotive DirectFET® Outline Dimension, L6 Outline (LargeSize Can).

Please see AN-1035 for DirectFET® assembly details and stencil and substrate design recommendations



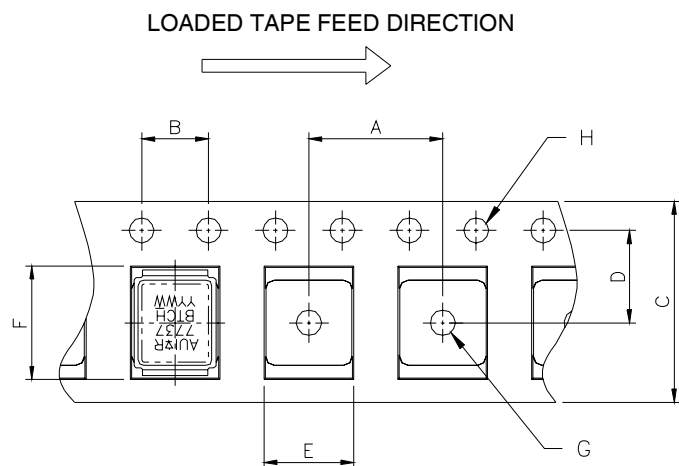
| DIMENSIONS |        |      |          |       |
|------------|--------|------|----------|-------|
|            | METRIC |      | IMPERIAL |       |
| CODE       | MIN    | MAX  | MIN      | MAX   |
| A          | 9.05   | 9.15 | 0.356    | 0.360 |
| B          | 6.85   | 7.10 | 0.270    | 0.280 |
| C          | 5.90   | 6.00 | 0.232    | 0.236 |
| D          | 0.55   | 0.65 | 0.022    | 0.026 |
| E          | 0.58   | 0.62 | 0.023    | 0.024 |
| F          | 1.18   | 1.22 | 0.046    | 0.048 |
| G          | 0.98   | 1.02 | 0.039    | 0.040 |
| H          | 0.73   | 0.77 | 0.029    | 0.030 |
| J          | 0.38   | 0.42 | 0.015    | 0.017 |
| K          | 1.35   | 1.45 | 0.053    | 0.057 |
| L          | 2.55   | 2.65 | 0.100    | 0.104 |
| L1         | 3.95   | 4.05 | 0.155    | 0.159 |
| L2         | 5.35   | 5.45 | 0.210    | 0.214 |
| M          | 0.68   | 0.74 | 0.027    | 0.029 |
| P          | 0.09   | 0.17 | 0.003    | 0.007 |
| R          | 0.02   | 0.08 | 0.001    | 0.003 |

## Automotive DirectFET® Part Marking



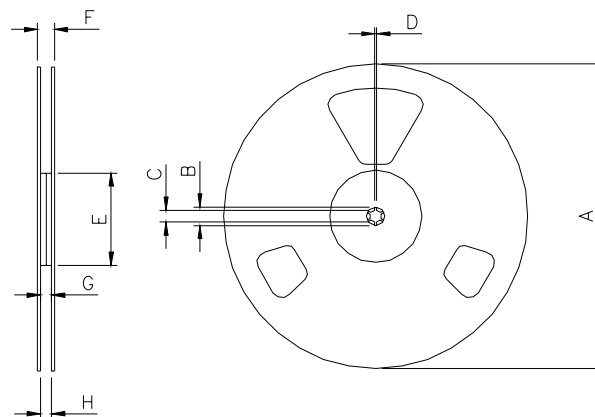
Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

## Automotive DirectFET® Tape & Reel Dimension (Showing component orientation).



NOTE: CONTROLLING  
DIMENSIONS IN MM

| DIMENSIONS |        |       |          |       |
|------------|--------|-------|----------|-------|
|            | METRIC |       | IMPERIAL |       |
| CODE       | MIN    | MAX   | MIN      | MAX   |
| A          | 11.90  | 12.10 | 4.69     | 0.476 |
| B          | 3.90   | 4.10  | 0.154    | 0.161 |
| C          | 15.90  | 16.30 | 0.623    | 0.642 |
| D          | 7.40   | 7.60  | 0.291    | 0.299 |
| E          | 7.20   | 7.40  | 0.283    | 0.291 |
| F          | 9.90   | 10.10 | 0.390    | 0.398 |
| G          | 1.50   | N.C   | 0.059    | N.C   |
| H          | 1.50   | 1.60  | 0.059    | 0.063 |



NOTE: Controlling dimensions in mm  
Std reel quantity is 4000 parts. (ordered as AUIRF7737L2TR). For 1000 parts on 7" reel, order AUIRF7737L2TR1

| REEL DIMENSIONS            |        |        |          |       |                       |       |          |      |
|----------------------------|--------|--------|----------|-------|-----------------------|-------|----------|------|
| STANDARD OPTION (QTY 4000) |        |        |          |       | TR1 OPTION (QTY 1000) |       |          |      |
|                            | METRIC |        | IMPERIAL |       | METRIC                |       | IMPERIAL |      |
| CODE                       | MIN    | MAX    | MIN      | MAX   | MIN                   | MAX   | MIN      | MAX  |
| A                          | 330.00 | N.C    | 12.992   | N.C   | 177.80                | N.C   | 7.000    | N.C  |
| B                          | 20.20  | N.C    | 0.795    | N.C   | 20.20                 | N.C   | 0.795    | N.C  |
| C                          | 12.80  | 13.20  | 0.504    | 0.520 | 12.98                 | 13.50 | 0.331    | 0.50 |
| D                          | 1.50   | N.C    | 0.059    | N.C   | 1.50                  | 2.50  | 0.059    | N.C  |
| E                          | 99.00  | 100.00 | 3.900    | 3.940 | 62.48                 | N.C   | 2.460    | N.C  |
| F                          | N.C    | 22.40  | N.C      | 0.880 | N.C                   | N.C   | N.C      | 0.53 |
| G                          | 16.40  | 18.40  | 0.650    | 0.720 | N.C                   | N.C   | N.C      | N.C  |
| H                          | 15.90  | 19.40  | 0.630    | 0.760 | 16.00                 | N.C   | 0.630    | N.C  |

### Notes:

- Click on this section to link to the appropriate technical paper.
- Click on this section to link to the DirectFET® Website.
- Surface mounted on 1 in. square Cu board, steady state.
- $T_C$  measured with thermocouple mounted to top (Drain) of part.
- Repetitive rating; pulse width limited by max. junction temperature.
- Starting  $T_J = 25^\circ\text{C}$ ,  $L = 0.024\text{mH}$ ,  $R_G = 50\Omega$ ,  $I_{AS} = 94\text{A}$ .
- Pulse width  $\leq 400\mu\text{s}$ ; duty cycle  $\leq 2\%$ .
- Used double sided cooling, mounting pad with large heatsink.
- Mounted on minimum footprint full size board with metalized back and with small clip heatsink.
- $R_\theta$  is measured at  $T_J$  of approximately  $90^\circ\text{C}$ .

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